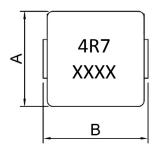
SPECIFICATION

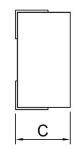
ITEM	SMD,INDUCTOR,4.7uH+-20%
FENG JUI P/N.	PI07024Q1-4R7M
ELECTRICAL	INDUCTANCE: 4.7uH±20%
REQUIREMENTS	DCR: $63.0 \text{m} \Omega$ MAX($45.2 \text{m} \Omega$ TYPICAL)
	Isat Current: 10.0A(drops 20% typ.)
	Irms Current: $4.5A(\triangle T=40^{\circ}C \text{ typ.})$

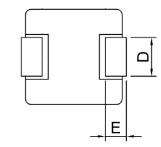
TEST METHOD:

TEST EQUIPMENT	CH1062A / CH1320
TEST FREQUENCY	100kHz, 0.25V
	AEC-Q200 Qualified

DIMENSION: (UNIT:mm)







A = 6.80 m/m MAX

B= 7.30 m/m MAX

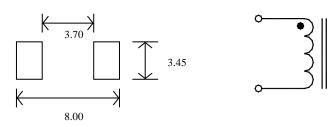
C= 2.40 m/m MAX

 $D= 3.00\pm0.30 \text{m/m}$

E= 1.50m/m REF.

LAND PATTERNS:

SCHEMATICS:



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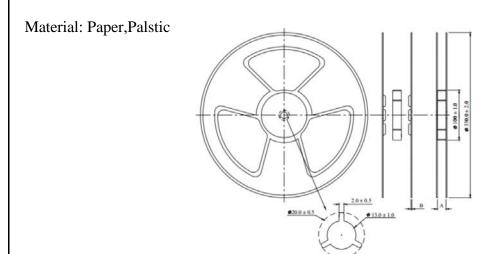
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SPECIFICATION

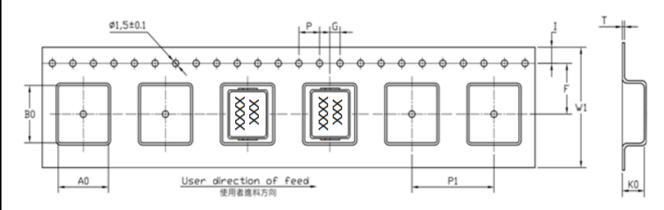
PACKAGING QUANTITIES

TYPE	Pcs / REEL
PI07024Q1	1,500

REEL DIMENSIONS UNIT:mm



A	16.5±0.2
В	2.00±0.2



UNIT:mm

W1	16.00±0.3
I	1.75±0.1
F	7.50±0.1
P	4.00±0.1

G	2.00±0.1
P1	12.00±0.1
Ao	7.10 REF.
T	0.40 ± 0.05

Во	7.60 REF.
Ko	2.60±0.1

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RELIABILITY TEST

- 1. Operating temperature range
 - -55 TO + 125°C (Includes temperature when the coil is heated)
- 2. High temperature exposure(storage) refer MIL-STD-202 Method 108:

1000 hrs at rated operating temperature(e.g. 125°C). Part can be stored for 1000 hrs @125°C.

Unpowered. Measurement at 24±4 hours after test conclusion.

- 3. Temperature cycling refer JESD22 Method JA-104:
 - 1000 cycles(-55 TO + 125°C). Measurement at 24±4 hours after test conclusion.

30 min maximum dwell time at each temp. extreme. 1 min. maximum transition time.

4. Biased Humidity refer MIL-STD-202 Method 103:

1000 hours 85°C/85%RH. Unpowered. Measurement at 24±4 hours after test conclusion.

5. Operational Life refer MIL-PRF-27:

1000 hrs. at 125 °C tested. Measurement at 24±4 hours after test conclusion.

6. External Visual refer MIL-STD-883 Method 2009:

Inspect device construction, marking and workmanship.

7. Physical Dimension refer JESD22 Method JB-100:

Verify physical dimensions to the applicable device detail specification.

8. Resistance to Solvents refer MIL-STD-202 Method 215:

Add aqueous wash chemical - OKEM clean or equivalent.

- 9. Mechanical Shock refer MIL-STD-202 Method 213: Figure 1 of Method 213. Condition C.
- 10. Vibration refer MIL-STD-202 Method 204:

5g's for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000 Hz.

11. Resistance to soldering Heat refer MIL-STD-202 Method 210:

Condition B No pre-heat of samples. Single wave solder-procedure 2 for SMD and procedure 1 for leaded with solder within 1.5mm of device body.

- 12. ESD refer AEC-Q200-002 or ISO/DIS 10605: Direct contact discharge 2kV.
- 13. Solderability refer J-STD-002: For SMD. Magnification 50X. Conditions:

SMD, a)Method B, $4hrs@155^{\circ}C$ dry heat $@235^{\circ}C$,

b)Method B@215°C category 3.,

c)Method D category 3@260°C

14. Electrical Characterization refer spec:

Show Min, Max Mean and Standard deviation at room from Min and Max temperature.

- 15. Flammability refer UL-94: V-0 or V-1 Acceptable.
- 16. Board Flex refer AEC-Q200-005: 60 sec minimum holding time.
- 17. Terminal Strength(SMD) refer AEC-Q200-006
- 18. Storage environment: MSL II

Storage condition: Temperature Range: 0° C ~ 35° C ; -55° C ~ 125° C (after PCB)

Humidity Range: 50% ~ 70% RH

Use components within 12 months. If 12 months or more have elapsed, check solderability before use.

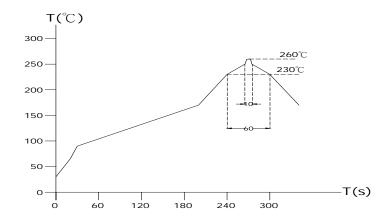
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ROHS SPECIFICATION

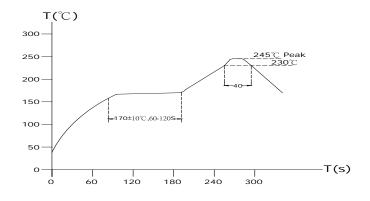
GENERAL CHARACTERISTICS

Lead-free heat endurance test



- *The test should be made under the conditions according to the chart, after the test it is kept for 2hours under the normal temperature and humidity.
 - Then,no mechanical and electrical defect should be found out.
- *The reflow test can be done twice, but the interval should be more than one hour under the normal conditions.
- *The reflow test conditions are based on the testing instruments available in our company.

Lead-free the recommended reflow condition



*The reflow condition recommended above is according to the machine used by our company.

Big differences will arise as a result of the type of machine ,reflow conditions,method,etc used.

Hence,before setting up your reflow conditions,please confirm with the above.

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